

Slater & Matsil, L.L.P.

Suite 1000
17950 Preston Road
Dallas, Texas 75252-5793
Phone: 972-732-1001 Facsimile: 972-732-9218

FACSIMILE COVER SHEET

To: Examiner Douglas W. Owens	Total Pages Sent: 28
Technology Center 2800	(including cover sheet)
Facsimile Number: (571) 273-8300	Transmission Date: March 15, 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Huang, *et al.* Docket No.: TSM03-0340
Serial No: 10/706,156 Art Unit: 2811
Date Filed: November 12, 2003
Title: Integration Film Scheme for Copper / Low-k Interconnect

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at (571) 273-8300 on the date shown above:

- Certification of Facsimile Transmission (1 page)
- Amendment Transmittal Letter (2 duplicate pages)
- Amendment (25 pages)

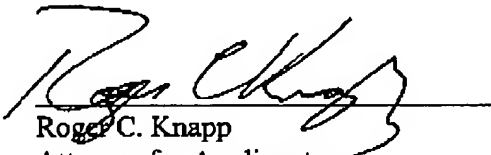
Respectfully submitted,



Kristin R. Hayes
Legal Assistant

Confirmation Respectfully Requested

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

AMENDMENT TRANSMITTAL LETTER				Attorney Docket No: TSM03-0340		
Application Serial Number: 10/706,156		Filing Date: November 12, 2003		Examiner: Douglas W. Owens		Group Art Unit: 2811
Invention: Integration Film Scheme for Copper / Low-k Interconnect						
TO THE COMMISSIONER OF PATENTS AND TRADEMARKS: Transmitted herewith is an amendment in the above-identified application. The fee has been calculated as shown below.						
CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	NO. OF EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	59	MINUS	29	30	\$50	\$ 1500.00
INDEP. CLAIMS	10	MINUS	4	6	\$200	\$ 1200.00
_____ Petition is hereby made under 37 CFR 1.136(a) to extend the time for response to the Office Action of <u>12/15/2005</u> to and through _____, comprising an extension of the shortened statutory period of: <div style="display: flex; justify-content: space-around; margin-top: 10px;"> <div> _____ one month (\$110) _____ two months (\$400) </div> <div> _____ three months (\$920) _____ four months (\$1,440) </div> </div>						
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$ 2700.00
_____ Applicant claims small entity status. See 37 CFR 1.27. Therefore the fee amount shown above is reduced by one-half, and the resulting fee is: \$ _____. _____ A check in the amount of \$ _____ is attached. <u> X </u> Charge \$ 2700.00 to Deposit Account <u>50-1065</u> . <u> X </u> Charge any additional fees or credit any overpayments to Deposit Account <u>50-1065</u> . _____ No additional fee is required.						
<u>March 15, 2006</u> Date			 Roger C. Knapp Attorney for Applicants Reg. No. 46,836			

COMMUNICATION

MAR 15 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Huang, *et al.* Docket No.: TSM03-0340
Serial No.: 10/706,156 Art Unit: 2811
Filed: November 12, 2003 Examiner: Owens, Douglas W.
For: Integration Film Scheme for Copper/Low-k Interconnect

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

Applicants respectfully request reconsideration of the claims in view of the following amendments and remarks, which are submitted as a full and complete response to the Examiner's Office Action dated December 15, 2005.

03/16/2006 HTECKLU1 00000055 501065 10706156

01 FC:1201 1200.00 DA
02 FC:1202 1500.00 DA